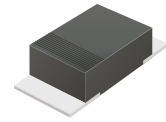


CDBB520-HF Thru. CDBB5200-HF

Reverse Voltage: 20-200 Volts

Forward Current: 5.0 Amp

RoHS Device

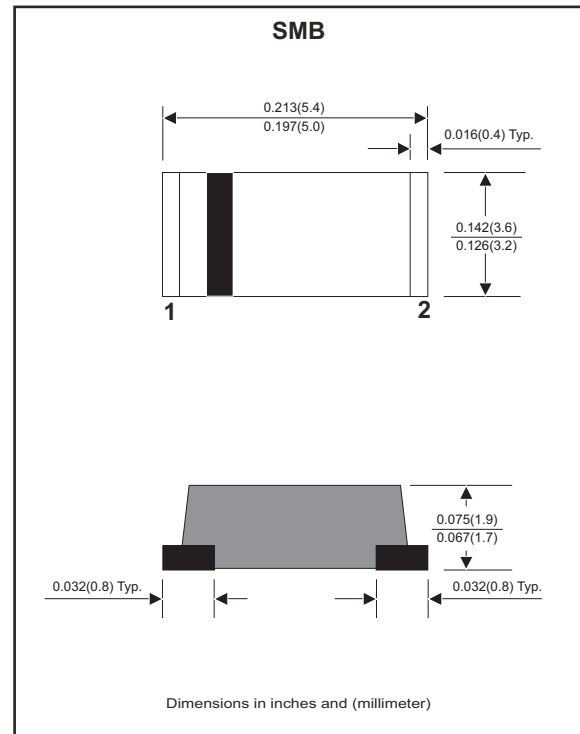


Features

- Halogen free.
- Batch process design, excellent power dissipation offers better reverse leakage current and thermal resistance.
- Low profile surface mounted application in order to optimize board space.
- Low power loss, high efficiency.
- High current capability, low forward voltage drop.
- High surge capability.
- Guardring for overvoltage protection.
- Ultra high-speed switching.
- Silicon epitaxial planar chip, metal silicon junction.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228

Mechanical data

- Case: Molded plastic, JEDEC SMB.
- Terminals: Solde plated, solderable per MIL-STD-750, method 2026.
- Polarity: Indicated by cathode band.
- Mounting position: Any
- Weight: 0.09 gram (approx.).



Symbol 1 : 2

Maximum Ratings (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	CONDITIONS	Symbol	MIN.	TYP.	MAX.	Unit
Forward rectified current	See Fig.1	I_o			5.0	A
Forward surge current	8.3ms half sine wave superimposed on rated load (JEDEC method)	I_{FSM}			150	A
Reverse current	CDBB520-HF~ CDBB540-HF	I_R			0.5	mA
	$V_R=V_{RRM}$ $T_A=25^\circ\text{C}$				20	
	CDBB550-HF~ CDBB5200-HF	I_R			0.5	mA
	$V_R=V_{RRM}$ $T_A=125^\circ\text{C}$				10	
Thermal resistance	Junction to ambient	$R_{\theta JA}$		46		$^\circ\text{C/W}$
	Junction to case	$R_{\theta JC}$		24		$^\circ\text{C/W}$
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C_J		380		pF
Storage temperature		T_{STG}	-65		+175	$^\circ\text{C}$

Note 1: f=1MHz and applied 4V DC reverse voltage.

REV:A

Maximum Ratings(at TA=25°C unless otherwise noted)

Parameter	Symbol	CDBB 520-HF	CDBB 530-HF	CDBB 540-HF	CDBB 550-HF	CDBB 560-HF	Unit
Repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	V
RMS voltage	V_{RMS}	14	21	28	35	42	V
Continuous reverse voltage	V_R	20	30	40	50	60	V
Maximum forward voltage @ $I_F=5.0A$	V_F	0.50	0.50	0.50	0.70	0.70	V
Operating junction temperature	T_J	-55 to +125			-55 to +150		°C

Parameter	Symbol	CDBB 580-HF	CDBB 5100-HF	CDBB 5150-HF	CDBB 5200-HF	Unit
Repetitive peak reverse voltage	V_{RRM}	80	100	150	200	V
RMS voltage	V_{RMS}	56	70	105	140	V
Continuous reverse voltage	V_R	80	100	150	200	V
Maximum forward voltage @ $I_F=5.0A$	V_F	0.85	0.85	0.90	0.92	V
Operating junction temperature	T_J	-55 to +150				°C

Rating and Characteristic Curves (CDBB520-HF Thru. CDBB5200-HF)

Fig.1-Typical Forward Current Derating Curve

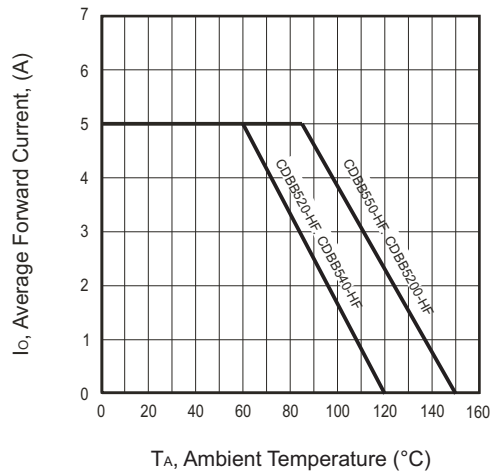


Fig.2-Typical Forward Characteristics

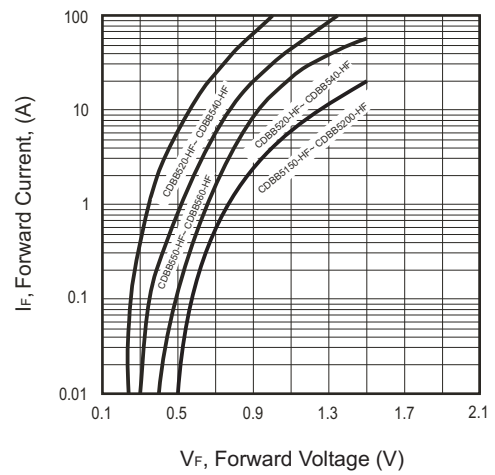


Fig.3 Maximum Non-repetitive Forward Surge Current

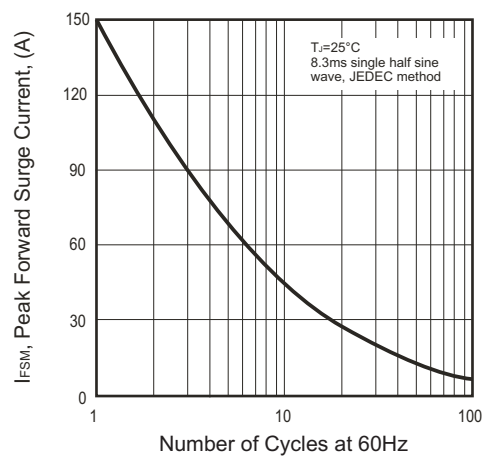


Fig.4-Typical Junction Capacitance

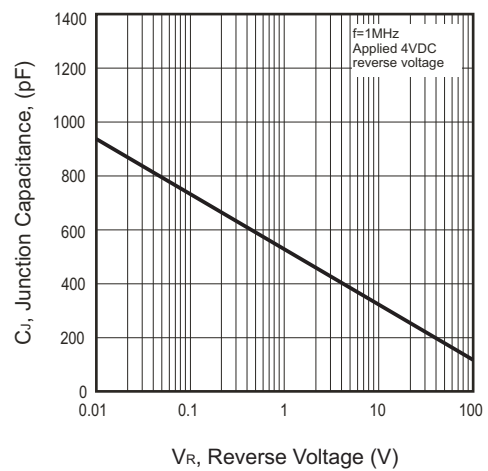
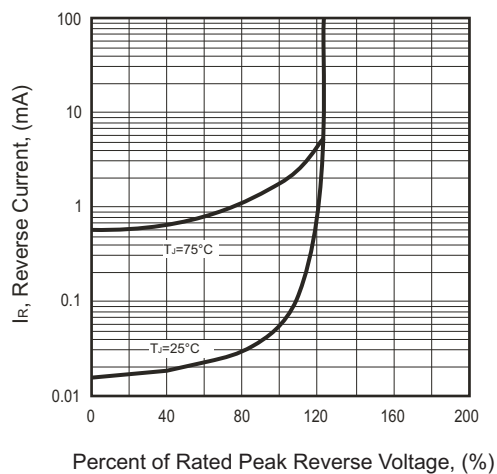
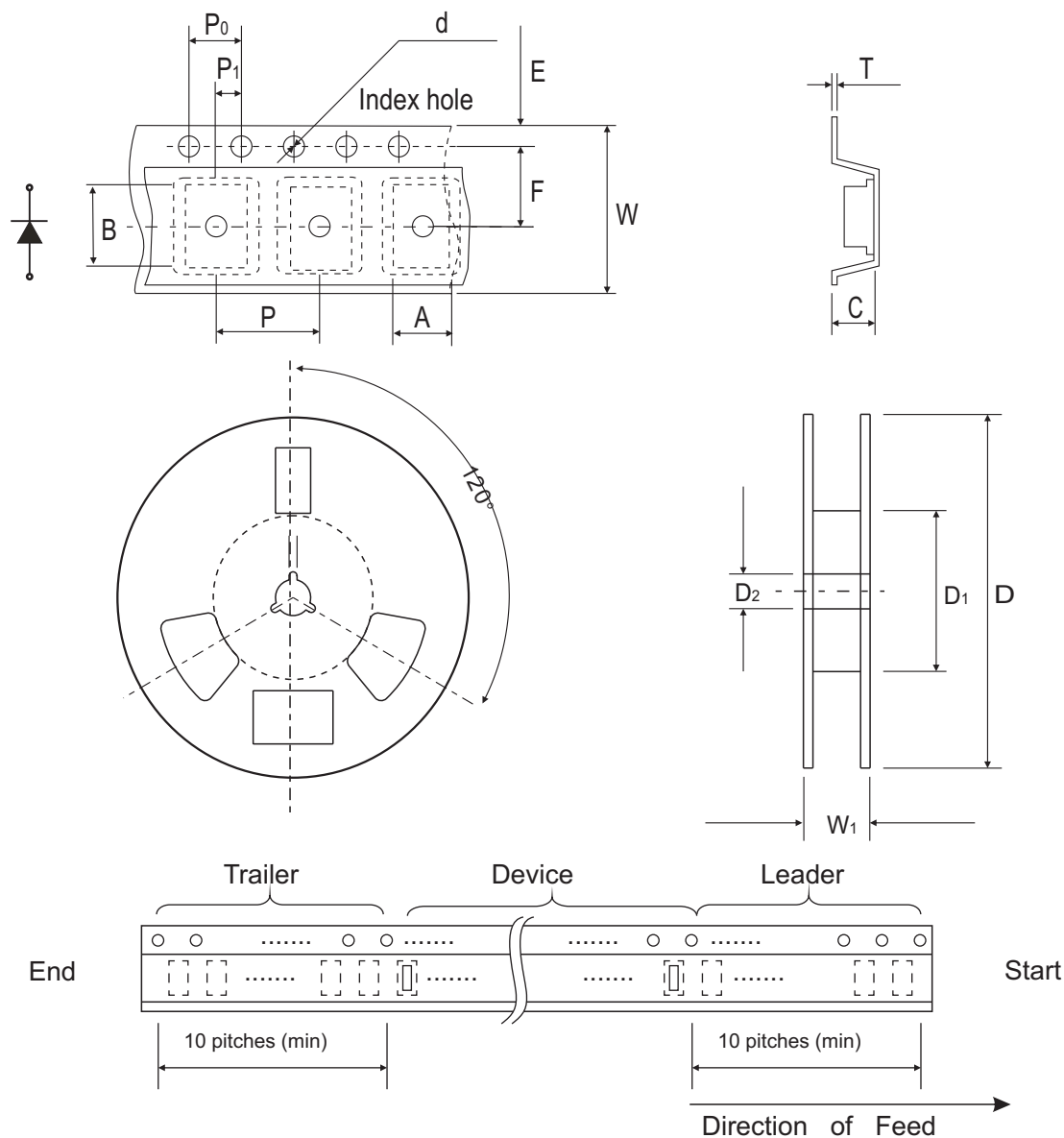


Fig.5-Typical Reverse Characteristics



Reel Taping Specification



SMB	SYMBOL	A	B	C	d	D	D ₁	D ₂
	(mm)	3.81 ± 0.10	5.74 ± 0.10	2.24 ± 0.10	1.50 ± 0.10	330 ± 2.00	50.0 MIN.	13.0 ± 0.50
	(inch)	0.150 ± 0.04	0.226 ± 0.04	0.088 ± 0.04	0.059 ± 0.004	12.99 ± 0.079	1.969 MIN.	0.512 ± 0.020

SMB	SYMBOL	E	F	P	P ₀	P ₁	T	W	W ₁
	(mm)	1.75 ± 0.10	5.50 ± 0.10	8.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	0.23 ± 0.10	12.0 ± 0.30	18.0 ± 1.00
	(inch)	0.689 ± 0.004	0.217 ± 0.004	0.315 ± 0.004	0.157 ± 0.004	0.079 ± 0.004	0.009 ± 0.004	0.472 ± 0.012	0.709 ± 0.040

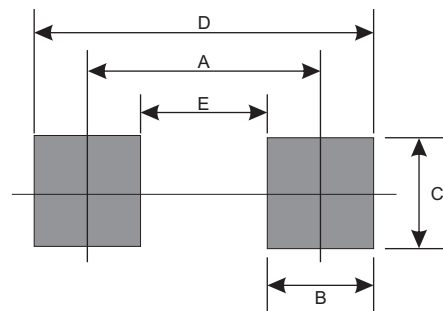
Marking Code

Part Number	Marking Code
CDBB520-HF	SS52
CDBB530-HF	SS53
CDBB540-HF	SS54
CDBB560-HF	SS56
CDBB580-G	SS58
CDBB5100-G	S510
CDBB5150-G	S515
CDBB5200-G	S520



Suggested PAD Layout

SIZE	SMB	
	(mm)	(inch)
A	4.50	0.177
B	1.50	0.059
C	3.60	0.142
D	6.00	0.236
E	3.00	0.118



Standard Package

Case Type	Qty per Reel	Reel Size
	(Pcs)	(inch)
SMB	4000	13